

TOSHIBA CMOS Digital Integrated Circuit Silicon Monolithic

# TC74VCX573FT

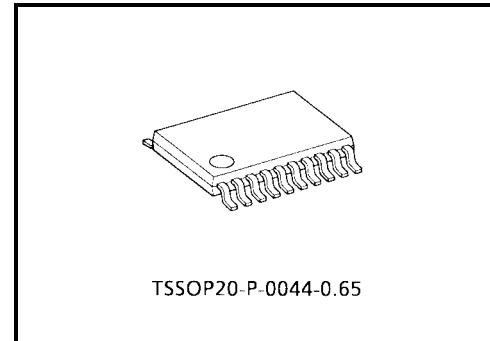
Low-Voltage Octal D-Type Latch with 3.6-V Tolerant Inputs and Outputs

The TC74VCX573FT is a high-performance CMOS octal D-type latch. Designed for use in 1.8-V, 2.5-V or 3.3-V systems, it achieves high-speed operation while maintaining the CMOS low power dissipation.

It is also designed with overvoltage tolerant inputs and outputs up to 3.6 V.

This 8 bit D-type latch is controlled by a latch enable input (LE) and an output enable input ( $\overline{OE}$ ). When the  $\overline{OE}$  input is high, the eight outputs are in a high-impedance state.

All inputs are equipped with protection circuits against static discharge.

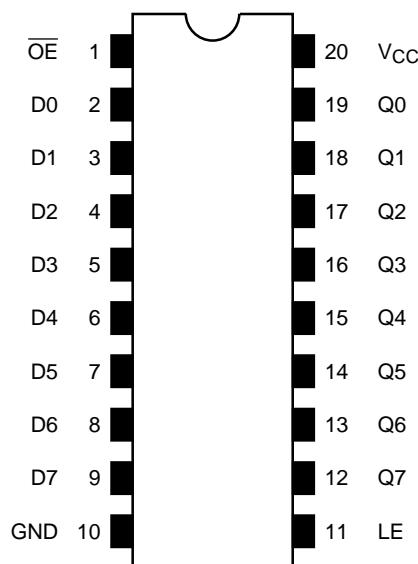


Weight: 0.08 g (typ.)

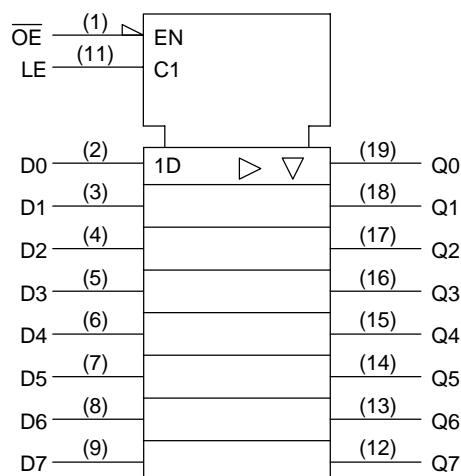
## Features

- Low-voltage operation:  $V_{CC} = 1.8$  to  $3.6$  V
- High-speed operation:  $t_{pd} = 4.2$  ns (max) ( $V_{CC} = 3.0$  to  $3.6$  V)
  - :  $t_{pd} = 4.7$  ns (max) ( $V_{CC} = 2.3$  to  $2.7$  V)
  - :  $t_{pd} = 9.4$  ns (max) ( $V_{CC} = 1.8$  V)
- Output current:  $I_{OH}/I_{OL} = \pm 24$  mA (min) ( $V_{CC} = 3.0$  V)
  - :  $I_{OH}/I_{OL} = \pm 18$  mA (min) ( $V_{CC} = 2.3$  V)
  - :  $I_{OH}/I_{OL} = \pm 6$  mA (min) ( $V_{CC} = 1.8$  V)
- Latch-up performance:  $\pm 300$  mA
- ESD performance: Machine model  $> \pm 200$  V
  - : Human body model  $> \pm 2000$  V
- Package: TSSOP (thin shrink small outline package)
- 3.6-V tolerant function and power-down protection provided on all inputs and outputs

## Pin Assignment (top view)



## IEC Logic Symbol



## Truth Table

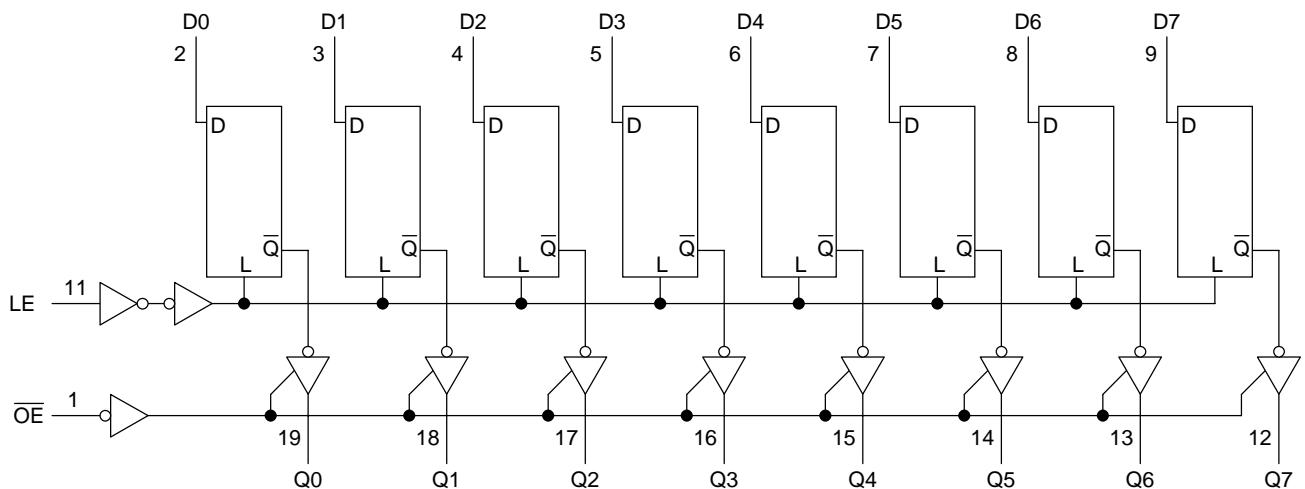
Inputs			Outputs
OE	LE	D	
H	X	X	Z
L	L	X	Qn
L	H	L	L
L	H	H	H

X: Don't care

Z: High impedance

Qn: Q outputs are latched at the time when the LE input is taken to a low logic level.

## System Diagram



## Maximum Ratings

Characteristics	Symbol	Rating	Unit
Power supply voltage	V <sub>CC</sub>	−0.5 to 4.6	V
DC input voltage	V <sub>IN</sub>	−0.5 to 4.6	V
DC output voltage	V <sub>OUT</sub>	−0.5 to 4.6 (Note 1)	V
		−0.5 to V <sub>CC</sub> + 0.5 (Note 2)	
Input diode current	I <sub>IK</sub>	−50	mA
Output diode current	I <sub>OK</sub>	±50 (Note 3)	mA
DC output current	I <sub>OUT</sub>	±50	mA
Power dissipation	P <sub>D</sub>	180	mW
DC V <sub>CC</sub> /ground current per supply pin	I <sub>CC</sub> /I <sub>GND</sub>	±100	mA
Storage temperature	T <sub>stg</sub>	−65 to 150	°C

Note 1: OFF state

Note 2: High or low state. I<sub>OUT</sub> absolute maximum rating must be observed.

Note 3: V<sub>OUT</sub> < GND, V<sub>OUT</sub> > V<sub>CC</sub>

## Recommended Operating Range

Characteristics	Symbol	Rating	Unit
Power supply voltage	V <sub>CC</sub>	1.8 to 3.6	V
		1.2 to 3.6 (Note 4)	
Input voltage	V <sub>IN</sub>	−0.3 to 3.6	V
Output voltage	V <sub>OUT</sub>	0 to 3.6 (Note 5)	V
		0 to V <sub>CC</sub> (Note 6)	
Output current	I <sub>OH</sub> /I <sub>OL</sub>	±24 (Note 7)	mA
		±18 (Note 8)	
		±6 (Note 9)	
Operating temperature	T <sub>opr</sub>	−40 to 85	°C
Input rise and fall time	dt/dv	0 to 10 (Note 10)	ns/V

Note 4: Data retention only

Note 5: OFF state

Note 6: High or low state

Note 7: V<sub>CC</sub> = 3.0 to 3.6 V

Note 8: V<sub>CC</sub> = 2.3 to 2.7 V

Note 9: V<sub>CC</sub> = 1.8 V

Note 10: V<sub>IN</sub> = 0.8 to 2.0 V, V<sub>CC</sub> = 3.0 V

**Electrical Characteristics****DC Characteristics (Ta = -40 to 85°C, 2.7 V < V<sub>CC</sub> ≤ 3.6 V)**

Characteristics		Symbol	Test Condition		V <sub>CC</sub> (V)	Min	Max	Unit	
Input voltage	H-level		V <sub>IH</sub>	—		2.7 to 3.6	2.0	—	
	L-level	V <sub>IL</sub>	—	—	2.7 to 3.6	—	0.8	V	
Output voltage	H-level	V <sub>OH</sub>	V <sub>IN</sub> = V <sub>IH</sub> or V <sub>IL</sub>	I <sub>OH</sub> = -100 μA	2.7 to 3.6	V <sub>CC</sub> - 0.2	—	V	
				I <sub>OH</sub> = -12 mA	2.7	2.2	—		
				I <sub>OH</sub> = -18 mA	3.0	2.4	—		
				I <sub>OH</sub> = -24 mA	3.0	2.2	—		
	L-level	V <sub>OL</sub>	V <sub>IN</sub> = V <sub>IH</sub> or V <sub>IL</sub>	I <sub>OL</sub> = 100 μA	2.7 to 3.6	—	0.2		
				I <sub>OL</sub> = 12 mA	2.7	—	0.4		
				I <sub>OL</sub> = 18 mA	3.0	—	0.4		
				I <sub>OL</sub> = 24 mA	3.0	—	0.55		
Input leakage current		I <sub>IN</sub>	V <sub>IN</sub> = 0 to 3.6 V		2.7 to 3.6	—	±5.0	μA	
3-state output OFF state current		I <sub>OZ</sub>	V <sub>IN</sub> = V <sub>IH</sub> or V <sub>IL</sub> V <sub>OUT</sub> = 0 to 3.6 V		2.7 to 3.6	—	±10.0	μA	
Power-off leakage current		I <sub>OFF</sub>	V <sub>IN</sub> , V <sub>OUT</sub> = 0 to 3.6 V		0	—	10.0	μA	
Quiescent supply current		I <sub>CC</sub>	V <sub>IN</sub> = V <sub>CC</sub> or GND		2.7 to 3.6	—	20.0	μA	
			V <sub>CC</sub> ≤ (V <sub>IN</sub> , V <sub>OUT</sub> ) ≤ 3.6 V		2.7 to 3.6	—	±20.0		
Increase in I <sub>CC</sub> per input		ΔI <sub>CC</sub>	V <sub>IH</sub> = V <sub>CC</sub> - 0.6 V		2.7 to 3.6	—	750		

**DC Characteristics (Ta = -40 to 85°C, 2.3 V ≤ V<sub>CC</sub> ≤ 2.7 V)**

Characteristics		Symbol	Test Condition		V <sub>CC</sub> (V)	Min	Max	Unit	
Input voltage	H-level		V <sub>IH</sub>	—		2.3 to 2.7	1.6	—	
	L-level	V <sub>IL</sub>	—	—	2.3 to 2.7	—	0.7	V	
Output voltage	H-level	V <sub>OH</sub>	V <sub>IN</sub> = V <sub>IH</sub> or V <sub>IL</sub>	I <sub>OH</sub> = -100 μA	2.3 to 2.7	V <sub>CC</sub> - 0.2	—	V	
				I <sub>OH</sub> = -6 mA	2.3	2.0	—		
				I <sub>OH</sub> = -12 mA	2.3	1.8	—		
				I <sub>OH</sub> = -18 mA	2.3	1.7	—		
	L-level	V <sub>OL</sub>	V <sub>IN</sub> = V <sub>IH</sub> or V <sub>IL</sub>	I <sub>OL</sub> = 100 μA	2.3 to 2.7	—	0.2		
				I <sub>OL</sub> = 12 mA	2.3	—	0.4		
				I <sub>OL</sub> = 18 mA	2.3	—	0.6		
				I <sub>OL</sub> = 24 mA	2.3 to 2.7	—	0.8		
Input leakage current		I <sub>IN</sub>	V <sub>IN</sub> = 0 to 3.6 V		2.3 to 2.7	—	±5.0	μA	
3-state output OFF state current		I <sub>OZ</sub>	V <sub>IN</sub> = V <sub>IH</sub> or V <sub>IL</sub> V <sub>OUT</sub> = 0 to 3.6 V		2.3 to 2.7	—	±10.0	μA	
Power-off leakage current		I <sub>OFF</sub>	V <sub>IN</sub> , V <sub>OUT</sub> = 0 to 3.6 V		0	—	10.0	μA	
Quiescent supply current		I <sub>CC</sub>	V <sub>IN</sub> = V <sub>CC</sub> or GND		2.3 to 2.7	—	20.0	μA	
			V <sub>CC</sub> ≤ (V <sub>IN</sub> , V <sub>OUT</sub> ) ≤ 3.6 V		2.3 to 2.7	—	±20.0		

DC Characteristics ( $T_a = -40$  to  $85^\circ\text{C}$ ,  $1.8 \text{ V} \leq V_{CC} < 2.3 \text{ V}$ )

Characteristics		Symbol	Test Condition		$V_{CC} (\text{V})$	Min	Max	Unit
Input voltage	H-level	$V_{IH}$	—		1.8 to 2.3	$0.7 \times V_{CC}$	—	V
	L-level	$V_{IL}$	—		1.8 to 2.3	—	$0.2 \times V_{CC}$	
Output voltage	H-level	$V_{OH}$	$V_{IN} = V_{IH}$ or $V_{IL}$	$I_{OH} = -100 \mu\text{A}$	1.8	$V_{CC} - 0.2$	—	V
	L-level	$V_{OL}$		$I_{OH} = -6 \text{ mA}$	1.8	1.4	—	
Input leakage current		$I_{IN}$	$V_{IN} = 0$ to $3.6 \text{ V}$		1.8	—	$\pm 5.0$	$\mu\text{A}$
3-state output OFF state current		$I_{OZ}$	$V_{IN} = V_{IH}$ or $V_{IL}$ $V_{OUT} = 0$ to $3.6 \text{ V}$		1.8	—	$\pm 10.0$	$\mu\text{A}$
Power-off leakage current		$I_{OFF}$	$V_{IN}, V_{OUT} = 0$ to $3.6 \text{ V}$		0	—	10.0	$\mu\text{A}$
Quiescent supply current		$I_{CC}$	$V_{IN} = V_{CC}$ or GND $V_{CC} \leq (V_{IN}, V_{OUT}) \leq 3.6 \text{ V}$		1.8	—	20.0	$\mu\text{A}$
					1.8	—	$\pm 20.0$	

AC Characteristics (Ta = -40 to 85°C, input:  $t_r = t_f = 2.0$  ns,  $C_L = 30$  pF,  $R_L = 500 \Omega$ )

Characteristics	Symbol	Test Condition	$V_{CC}$ (V)	Min	Max	Unit
Propagation delay time (D-Q)	$t_{pLH}$ $t_{pHL}$	Figure 1, Figure 2	1.8	1.5	9.4	ns
			$2.5 \pm 0.2$	0.8	4.7	
			$3.3 \pm 0.3$	0.6	4.2	
Propagation delay time (LE-Q)	$t_{pLH}$ $t_{pHL}$	Figure 1, Figure 2	1.8	1.5	9.8	ns
			$2.5 \pm 0.2$	0.8	4.9	
			$3.3 \pm 0.3$	0.6	4.2	
3-state output enable time	$t_{pZL}$ $t_{pZH}$	Figure 1, Figure 3	1.8	1.5	9.8	ns
			$2.5 \pm 0.2$	0.8	5.5	
			$3.3 \pm 0.3$	0.6	4.5	
3-state output disable time	$t_{pLZ}$ $t_{pHZ}$	Figure 1, Figure 3	1.8	1.5	6.5	ns
			$2.5 \pm 0.2$	0.8	3.6	
			$3.3 \pm 0.3$	0.6	3.3	
Minimum pulse width (LE)	$t_w$ (H)	Figure 1, Figure 2	1.8	4.0	—	ns
			$2.5 \pm 0.2$	1.5	—	
			$3.3 \pm 0.3$	1.5	—	
Minimum set-up time	$t_s$	Figure 1, Figure 2	1.8	2.5	—	ns
			$2.5 \pm 0.2$	1.5	—	
			$3.3 \pm 0.3$	1.5	—	
Minimum hold time	$t_h$	Figure 1, Figure 2	1.8	1.0	—	ns
			$2.5 \pm 0.2$	1.0	—	
			$3.3 \pm 0.3$	1.0	—	
Output to output skew	$t_{osLH}$ $t_{osHL}$	(Note 11)	1.8	—	0.5	ns
			$2.5 \pm 0.2$	—	0.5	
			$3.3 \pm 0.3$	—	0.5	

For  $C_L = 50$  pF, add approximately 300 ps to the AC maximum specification.

Note 11: Parameter guaranteed by design.

$$(t_{osLH} = |t_{pLHm} - t_{pLHn}|, t_{osHL} = |t_{pHLm} - t_{pHLn}|)$$

**Dynamic Switching Characteristics ( $T_a = 25^\circ C$ , input:  $t_r = t_f = 2.0 \text{ ns}$ ,  $C_L = 30 \text{ pF}$ )**

Characteristics	Symbol	Test Condition	$V_{CC} (\text{V})$	Typ.	Unit
Quiet output maximum dynamic $V_{OL}$	$V_{OLP}$	$V_{IH} = 1.8 \text{ V}, V_{IL} = 0 \text{ V}$ (Note 12)	1.8	0.25	V
		$V_{IH} = 2.5 \text{ V}, V_{IL} = 0 \text{ V}$ (Note 12)	2.5	0.6	
		$V_{IH} = 3.3 \text{ V}, V_{IL} = 0 \text{ V}$ (Note 12)	3.3	0.8	
Quiet output minimum dynamic $V_{OL}$	$V_{OLV}$	$V_{IH} = 1.8 \text{ V}, V_{IL} = 0 \text{ V}$ (Note 12)	1.8	-0.25	V
		$V_{IH} = 2.5 \text{ V}, V_{IL} = 0 \text{ V}$ (Note 12)	2.5	-0.6	
		$V_{IH} = 3.3 \text{ V}, V_{IL} = 0 \text{ V}$ (Note 12)	3.3	-0.8	
Quiet output minimum dynamic $V_{OH}$	$V_{OHV}$	$V_{IH} = 1.8 \text{ V}, V_{IL} = 0 \text{ V}$ (Note 12)	1.8	1.5	V
		$V_{IH} = 2.5 \text{ V}, V_{IL} = 0 \text{ V}$ (Note 12)	2.5	1.9	
		$V_{IH} = 3.3 \text{ V}, V_{IL} = 0 \text{ V}$ (Note 12)	3.3	2.2	

Note 12: Parameter guaranteed by design.

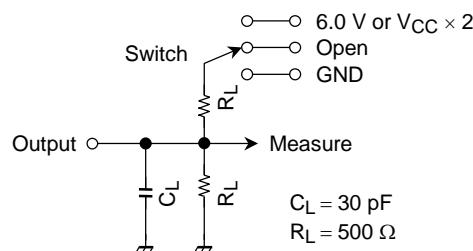
**Capacitive Characteristics ( $T_a = 25^\circ C$ )**

Characteristics	Symbol	Test Condition	$V_{CC} (\text{V})$	Typ.	Unit
Input capacitance	$C_{IN}$	—	1.8, 2.5, 3.3	6	pF
Output capacitance	$C_O$	—	1.8, 2.5, 3.3	7	pF
Power dissipation capacitance	$C_{PD}$	$f_{IN} = 10 \text{ MHz}$ (Note 13)	1.8, 2.5, 3.3	20	pF

Note 13:  $C_{PD}$  is defined as the value of the internal equivalent capacitance which is calculated from the operating current consumption without load.

Average operating current can be obtained by the equation:

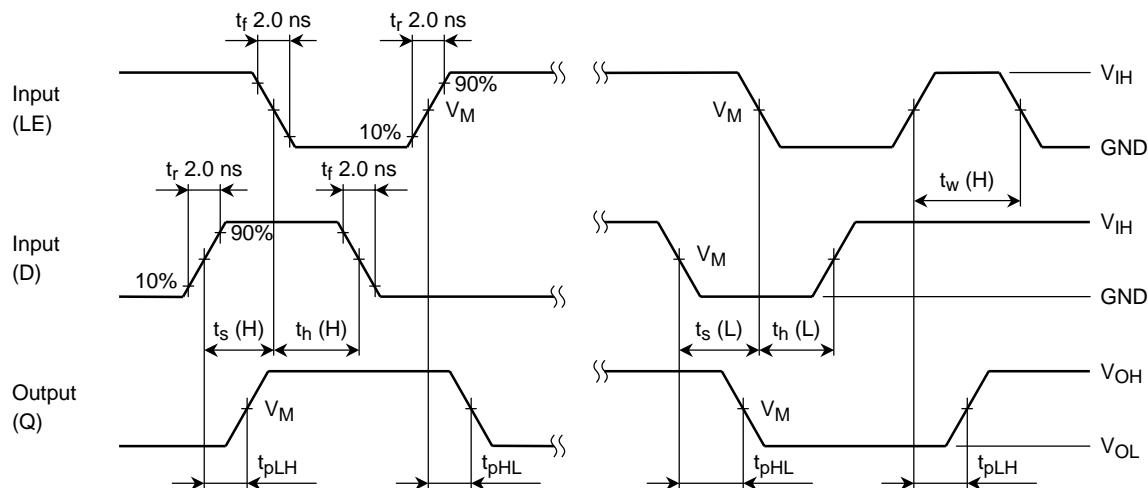
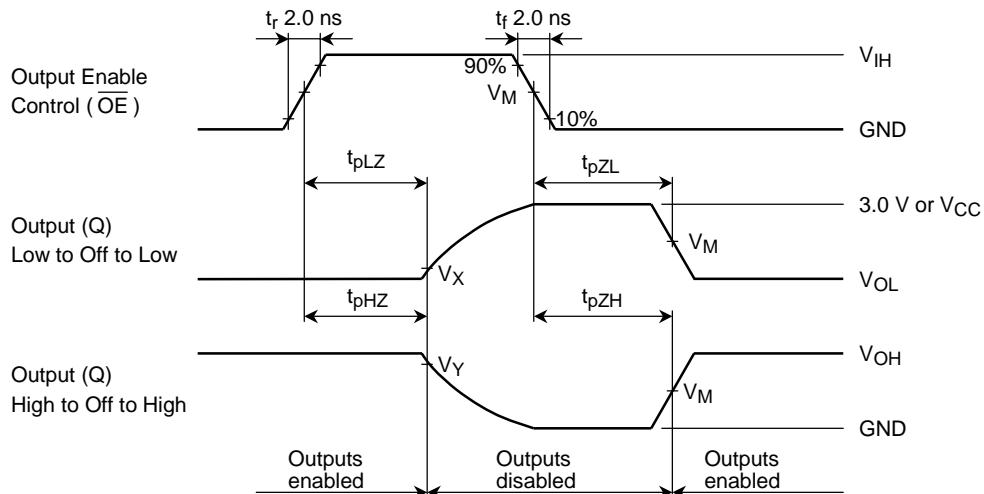
$$I_{CC} (\text{opr}) = C_{PD} \cdot V_{CC} \cdot f_{IN} + I_{CC}/8 \text{ (per bit)}$$

**AC Test Circuit**

Parameter	Switch
$t_{pLH}, t_{pHL}$	Open
$t_{pLZ}, t_{pZL}$	6.0 V $V_{CC} \times 2$ $@V_{CC} = 3.3 \pm 0.3 \text{ V}$ $@V_{CC} = 2.5 \pm 0.2 \text{ V}$ $@V_{CC} = 1.8 \text{ V}$
$t_{pHZ}, t_{pZH}$	GND

**Figure 1**

## AC Waveform

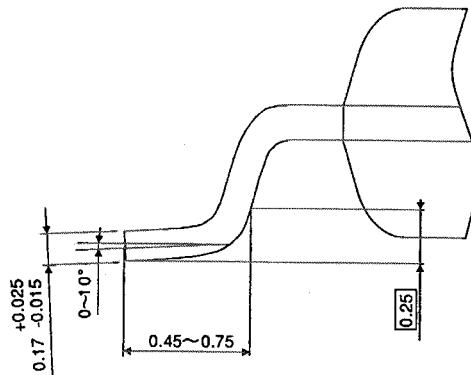
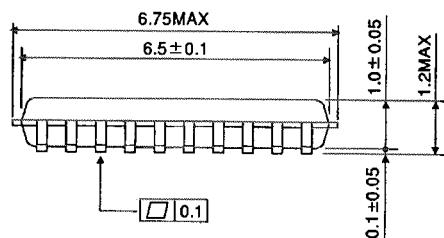
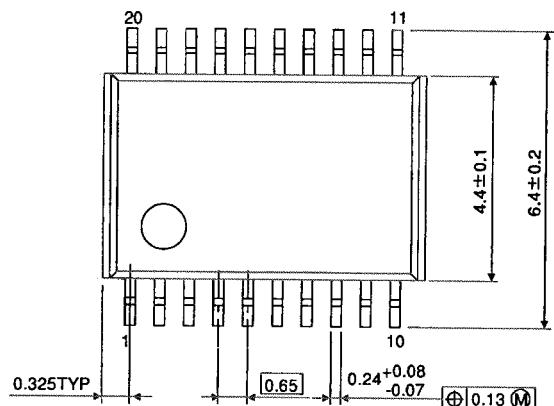
Figure 2  $t_{pLH}$ ,  $t_{pHL}$ ,  $t_w$ ,  $t_s$ ,  $t_h$ Figure 3  $t_{pLZ}$ ,  $t_{pHZ}$ ,  $t_{pZL}$ ,  $t_{pZH}$ 

Symbol	$V_{CC}$		
	$3.3 \pm 0.3\text{ V}$	$2.5 \pm 0.2\text{ V}$	$1.8\text{ V}$
$V_{IH}$	2.7 V	$V_{CC}$	$V_{CC}$
$V_M$	1.5 V	$V_{CC}/2$	$V_{CC}/2$
$V_X$	$V_{OL} + 0.3\text{ V}$	$V_{OL} + 0.15\text{ V}$	$V_{OL} + 0.15\text{ V}$
$V_Y$	$V_{OH} - 0.3\text{ V}$	$V_{OH} - 0.15\text{ V}$	$V_{OH} - 0.15\text{ V}$

**Package Dimensions**

TSSOP20-P-0044-0.65

Unit : mm



Weight: 0.08 g (typ.)

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000707EBA

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